

Rotary Switch SB30





Switch for conventional wiring and direct soldering to printed circuits.

- Detent angle 30° or 15° with 12 or 24 switching positions.
- Mounting dimensions 22 x 34 mm.
- Exact positioning by means of special detent mechanism.
- Screwed if more than 3 wafers

1.0 Construction	
1.1 Number of wafers max.	4 wafers in 4-pole design
1.2 Switching combination per wafer Design B, detent angle 60° non-shorting	— 1x6 to 1x2; 2x3 to 2x2; 3x2
Design E, detent angle 30°, standard non-shorting	1x12 to1x2; 2x6 to 2x2 3x4 to 3x2; 4x4 to 4x2
Design P, detent angle 15° shorting	1x24 to1x2; 2x12 to 2x2 3x8 to 3x2; 4x6 to 4x2
1.3 Contacts 1.4 Mounting	Soldering lugs or pins Central mounting

2.0 Electrical Data		
2.1 Switching power max.		6VA/W
2.2 Switching voltage max.		60 V≃
2.3 Switching current max.		500 mA
2.4 Rest current max. at ∂u	20°C	≤3A
2.5 Test voltage at 50 Hz		500 V
2.6 Life expectancy	without power	≥20 000 cycles
	with power	≥10000 cycles
2.7 Contact resistance	initial value	≤15 mΩ
Contact resistance	without electrical load	≤20 mΩ
after life expectancy	with electrical load	≤25 mΩ
2.8 Insulation resistance		≥10 ¹¹ Ω
2.9 Capacity between 2 contacts		≤0,8 pF
Capacity between contact and ground		≤0,8 pF

3.0 Mechanical Data				
3.1 Switching mode	shorting	Detent angle 15°		
	non-shorting*	Detent angle 30° and 60°		
3.2 Stops		Fixed or without stop		
3.3 Operating torque acc. to design		≥3 Ncm		
3.4 Stop strength		≥ 150 Ncm		
3.5 Fastening torque max.		150 Ncm		
3.6 Vibratory strength		10 g, 10-500 Hz		
3.7 Shock strength		50 g, 11 ms		
3.8 Waterproofing		As special design with 30° detent angle		

^{*} Shorting by external connection

4.0 Other Data		
4.1 Contact material		Ag; Au as special design
4.2 Insulating material	Wafer	Diallylphthalate, DAP; Code DI
	Rotor	Polyacetal, POM
4.3 Soldering time and temperature max.		5s at 260°C
		3's at 350°C, manual soldering



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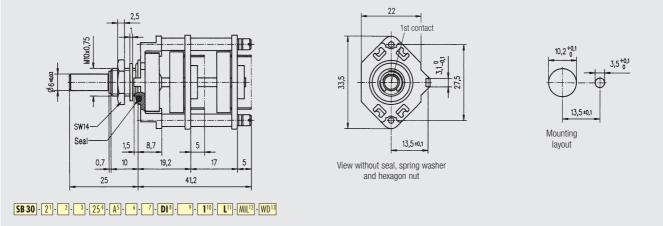
The bold-typed data in the yellow order blocks remain unchanged.

Normal-typed data match the drawings and can be modified according to your wishes.

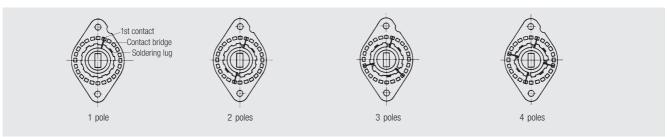
Blanks need to be completed according to the ordering details on the inside front cover.

Dimensional Drawings · Dimensions in mm Screwed with more than 3 wafers 1st contact 1st conta

SB30 · Standard version



SB 30 · MIL-version



 $\ensuremath{\mathsf{SB\,30}}\xspace$ Contact surfaces viewed from detent mechanism. Contact bridges in left hand stop position

